

# MOS INTEGRATED CIRCUIT

# $\mu$ PD6127

## MULTI-PURPOSE REMOTE CONTROL TRANSMITTER IC

### CMOS LSI

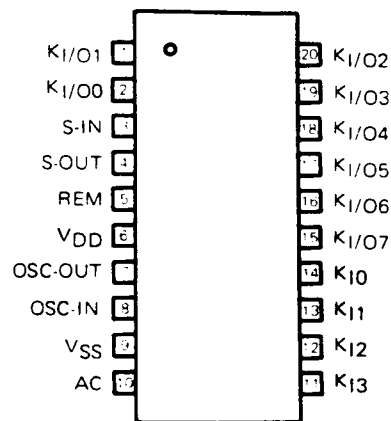
The  $\mu$ PD6127 is intended for applications in infrared remote control transmitters for controlling TV, VCR, stereo components, cassette decks, airconditioners, and other appliance.

It consists of a 1 k step ROM (10 bits/step), 32 word RAM (5 bits/word), 4 bit parallel processing ALU, programmable timer, key input/output ports, and a transmission/output port. The remote-control transmitter functions can be programmed.

### FEATURES

- Programmable infrared remote-control transmitter
- 19 instructions
- Instruction cycle  
20  $\mu$ s/400 kHz (ceramic resonator)
- Program memory (ROM) size  
1 024 x 10 bits
- Data memory (RAM) size  
32 x 5 bits
- Programmable timer (9 bits)
- I/O: 8 pins  
Input: 4 pins  
Serial input: 1 pin
- Send carrier frequency  
 $f_{osc}/12, f_{osc}$
- Standby operation (HALT)
- Ceramic oscillation circuit for system clock
- CMOS
- Low power consumption
- Low operating voltage (2.0 to 6.0 V)

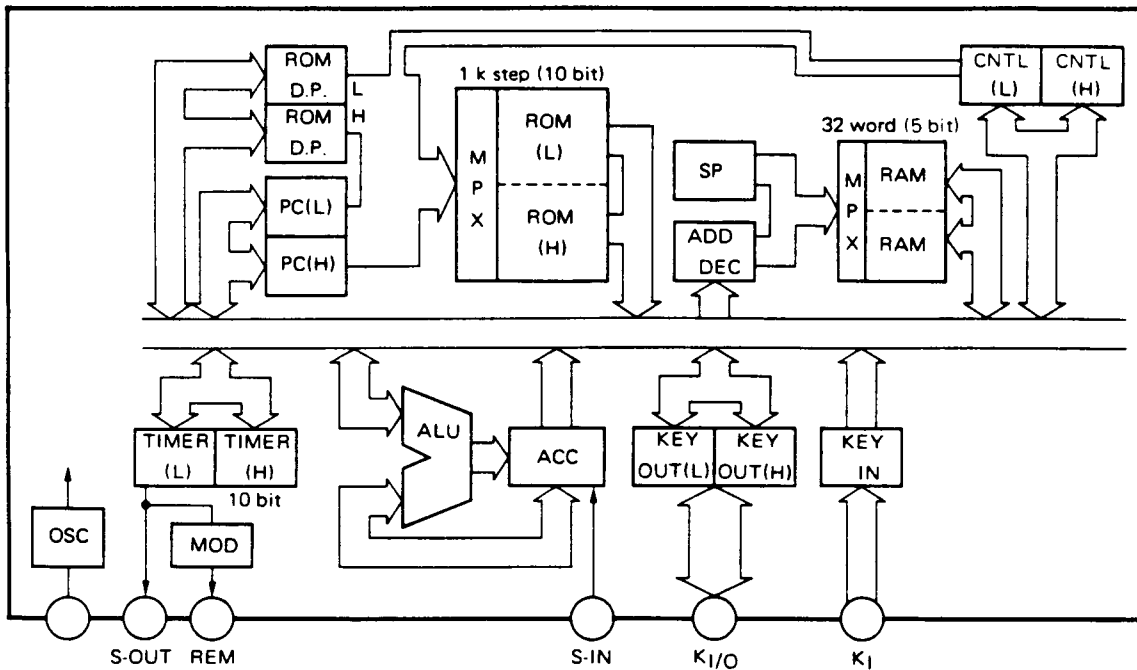
### PIN CONFIGURATION (Top View)



### ORDERING INFORMATION

Order Code	Package
$\mu$ PD6127GS	20-pin plastic SOP (300 mil)
$\mu$ PD6127CS	20-pin plastic SHRINK DIP (300 mil)

## BLOCK DIAGRAM



## 1. INTERNAL BLOCK FUNCTIONS

### 1.1 PROGRAM COUNTER (PC) ... 10 bits

This is a 10 bit binary counter for setting the 10 bit address information of the program memory.

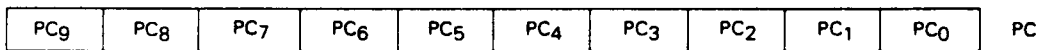


Fig. 1.1 Program counter configuration

Each time an instruction is executed, the program counter is automatically incremented by the number of bytes of the instruction.

When a jump instruction (JMP0, JC, JF) is executed, the program counter indicates the jump destination. The immediate data or data memory contents are loaded into some or all bits of the program counter.

When a call instruction (CALL0) is executed, the program counter contents are incremented and saved in the stack memory. Then, values required for each jump instruction are loaded. When a return instruction (RET) is executed, the stack memory contents are incremented by two and loaded into the program counter.

When an all clear command is input, the program counter is initialized to 000.

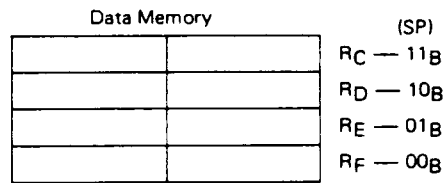
### 1.2 STACK POINTER (SP) ... 2 bits

This is a 2-bit register storing the stack area starting address, when the data memory is used as a stack memory.

The stack pointer is incremented when a call instruction (CALL0) is executed and decremented when a return instruction (RET) is executed.

The stack pointer is initialized to 00<sub>H</sub> after all-clear operation, and sets the most significant address (F<sub>H</sub>) of the data memory.

The relationship between stack pointers and data memory area are as follows:



When a stack pointer overflows, it is assumed that the CPU ran out of control and the program counter is initialized to 000.

### 1.3 PROGRAM MEMORY (ROM) ··· 1 024 steps x 10 bits

This is a mask programmable ROM (1 024 steps x 10 bits) addressed by the program counter.

The program memory stores a program, table data, and so forth.

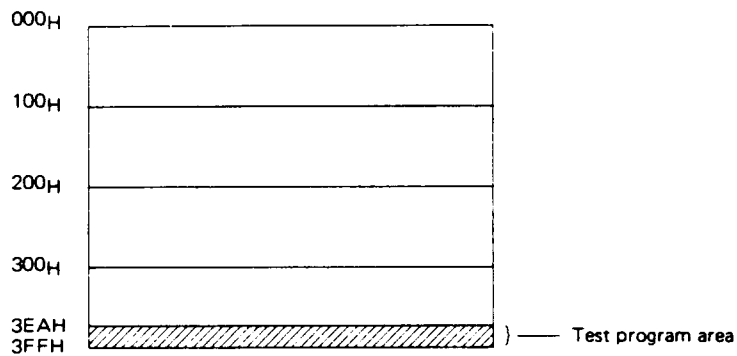


Fig. 1.2 Program memory map

The program memory address is 000H-3FFH.

Users cannot use the test program area.

### 1.4 DATA MEMORY (RAM) ··· 32 words x 5 bits

This is a static RAM (32 word x 5 bits) used for storing processing data. The data memory may be handled in 8 bit units. R<sub>0</sub> can be used as the ROM data pointer.

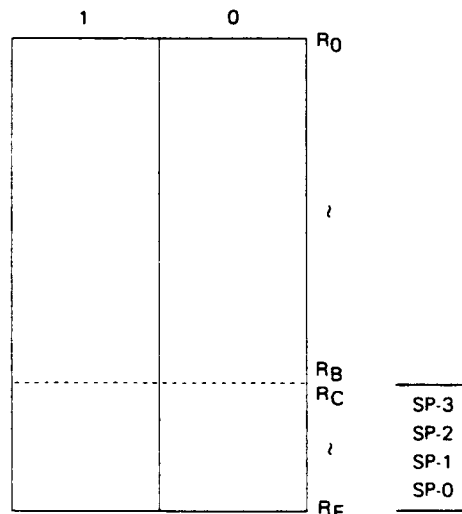


Fig. 1.3 Data memory configuration

### 1.5 DATA POINTER (R<sub>0</sub>)

R<sub>0</sub> (R<sub>10</sub>, R<sub>00</sub>) of the data memory can be used as a ROM data pointer.

R<sub>0</sub> specifies eight lower bits of the ROM address, and the two upper bits are specified by the control register.

Setting a ROM address in the data pointer will facilitate reference of a ROM data table.

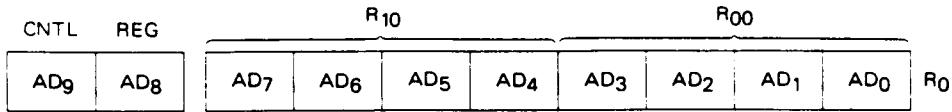


Fig. 1.4 Data pointer configuration

### 1.6 ACCUMULATOR (A) ··· 4 bits

The accumulator is a 4-bit register used for various operations.

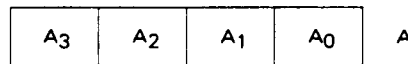


Fig. 1.5 Accumulator configuration

### 1.7 ARITHMETIC LOGIC UNIT (ALU) ··· 4 bits

The arithmetic logic unit is a 4-bit operation circuit used for simple processing such as logical operations.

### 1.8 FLAG

#### (1) Status flag

If the port status checked by an STTS instruction matches the condition specified by this instruction, the status flag (F) is set (to 1).

#### (2) Carry flag

If the accumulator's MSB causes carry when an INC (increment) or RL (rotate shift) instruction is executed, the carry flag (C) is set (to 1).

If the accumulator contents indicate F<sub>H</sub> when a SCAF instruction is executed, the carry flag (C) is set (to 1).

### 1.9 SYSTEM CLOCK GENERATION CIRCUIT

The system clock generation circuit is comprised of a ceramic vibrator (400 to 500 kHz) oscillator.

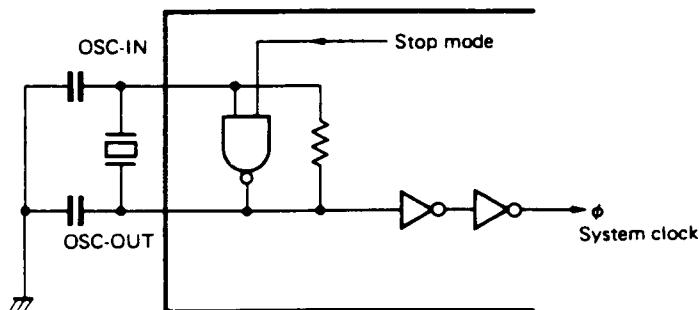


Fig. 1.6 System clock generation circuit

The system clock generation circuit stops the oscillator (system clock φ) in the stop mode.

## 1.10 TIMER

The timer decides transmission output pattern. The timer consists of the 9 bit down-counter block and the 1 bit register to decide whether carrier pulses are output or not. (10 bits in total)

The 9 bit down-counter decrements by 1 every instruction execution ( $8/f_{OSC}$ ) at the timer run mode. When the 9 bit down-counter value becomes 000, the timer operation stops and halt reset signal is out. If CPU operation state is the HALT TIMER mode (waiting for timer up), the halt mode is reset and next instruction is operated.

The count down time is decided by the following expression (set up value (HEX) + 1)  $\times 8/f_{OSC}$ . This value is set by timer operation instructions. (MOV  $T_t$ , A, MOV T, #data . . .)

According to the MSB register value, the REM output signal is selected whether carrier pulses or low level. When the MSB is 1, carrier pulses ( $f_{OSC}/12$  or  $f_{OSC}$ ) are output until the 9 bit down-counter value goes to 000. When the MSB is 0, the REM output level is low.

At the S-OUT pin the MSB inverted level is output. When carrier pulses are output at the REM output, the S-OUT output level is low. When carrier pulses are not output from the REM output, the S-OUT output level is high.

The OSCILLATION STOP HALT instruction is not executed until the 9 bit down-counter value becomes 000. If the HALT reset condition is match during the timer running, HALT mode is reset immediately then the next instruction is executed.

The timer start/stop is controlled by the control register ( $P_1$ ). (See the explanation of the control register)

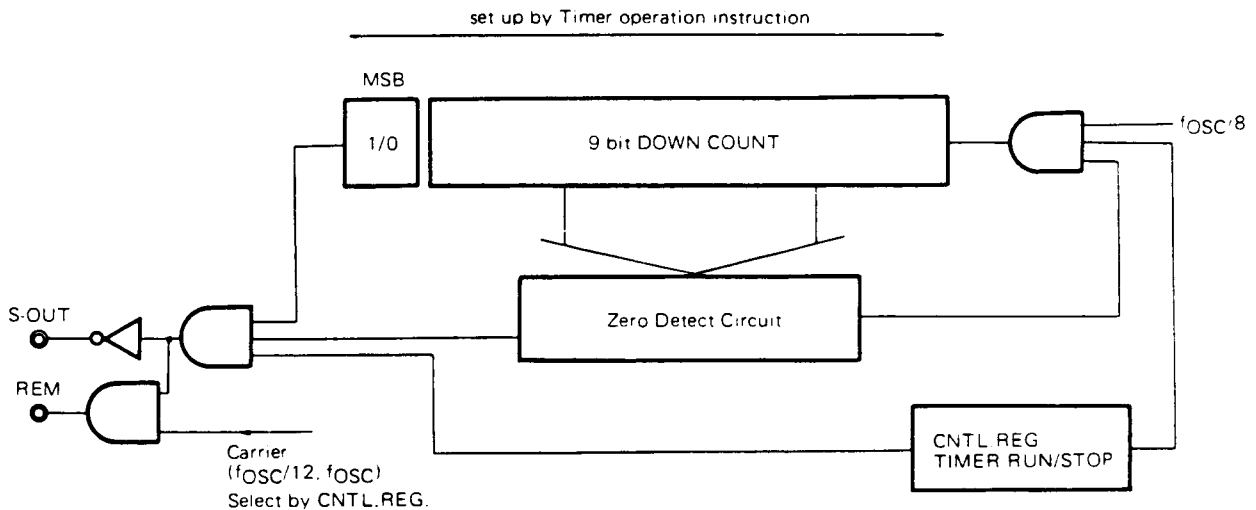


Fig. 1.7 Timer block configuration

### 1.11 SERIAL INPUT PORT

Serial data is input from a serial input port. When the control register ( $P_1$ ) is set in the serial input mode, the serial input port is connected to the LSB of the accumulator and the serial input port is pulled down to the  $V_{SS}$  level within the LSI chip. If the left shift instruction is executed for the accumulator, the serial input port data is set in the LSB of the accumulator.

If the serial input mode is canceled, the serial input pin impedance is made high.

When the left shift instruction is executed for the accumulator, the MSB data is set in the LSB.

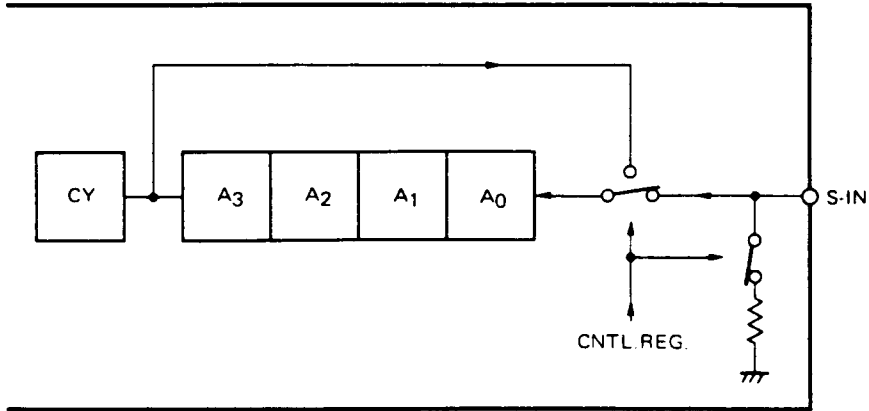


Fig. 1.8 Serial input port configuration

### 1.12 $K_{I/O}$ PORT ( $P_0$ )

This is an 8 bit port for key scan output. When the control register ( $P_1$ ) is set in the input mode, this port can be used as an 8 bit input port. In this case, all pins are pulled down to the  $V_{SS}$  level.

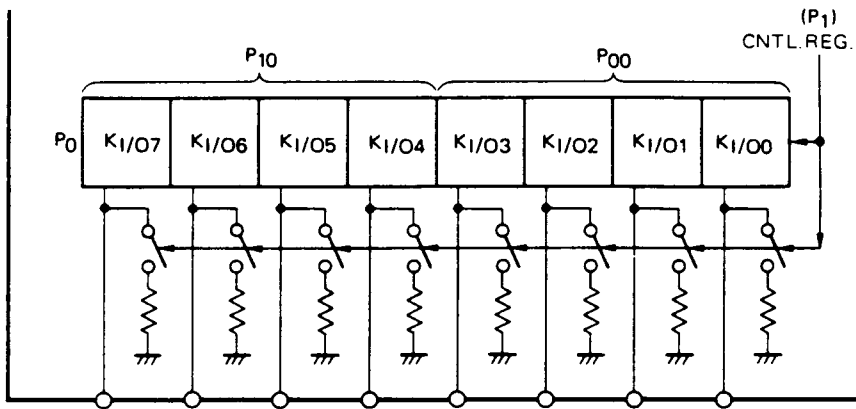


Fig. 1.9  $K_{I/O}$  port configuration

### 1.13 K<sub>I</sub> PORT (P<sub>12</sub>)

This is a 4 bit input port for key input. All pins are pulled down to the V<sub>SS</sub> level.

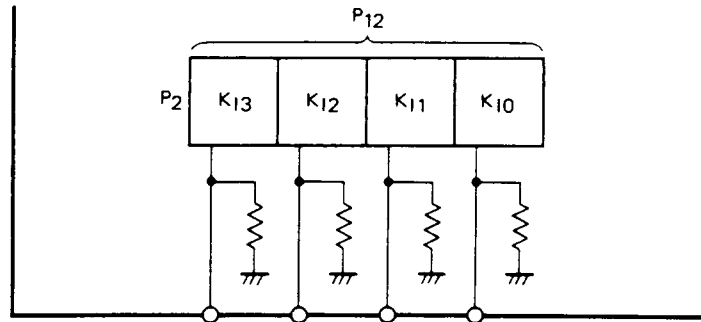
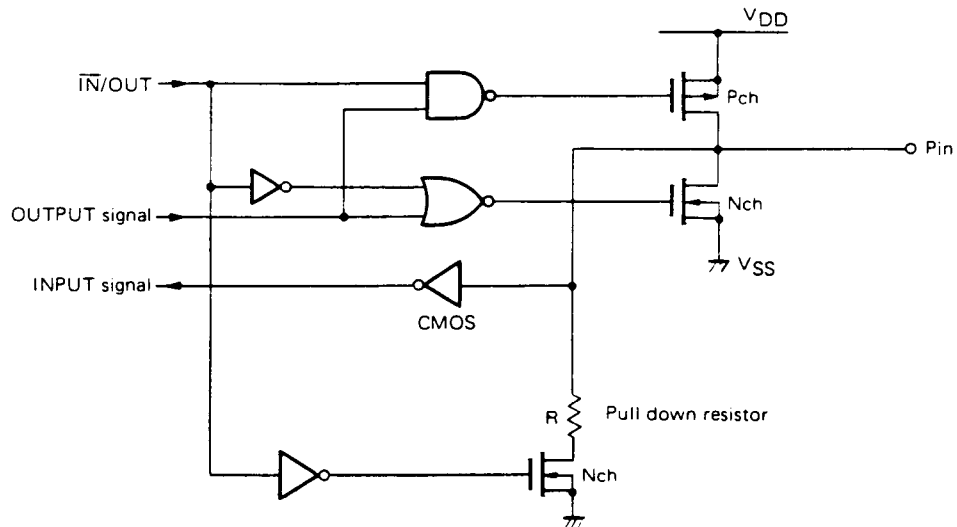


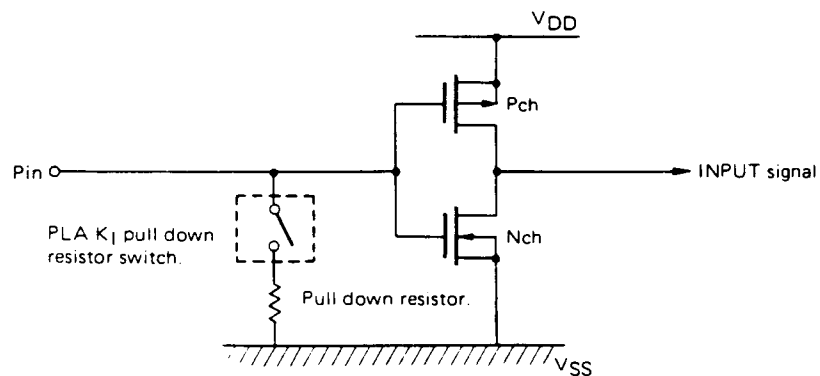
Fig. 1.10 K<sub>I</sub> port configuration

### 1.14 K<sub>I/O</sub> pull down resistors



When the K<sub>I/O</sub> port is set to the input mode, pull-down resistors are activated.

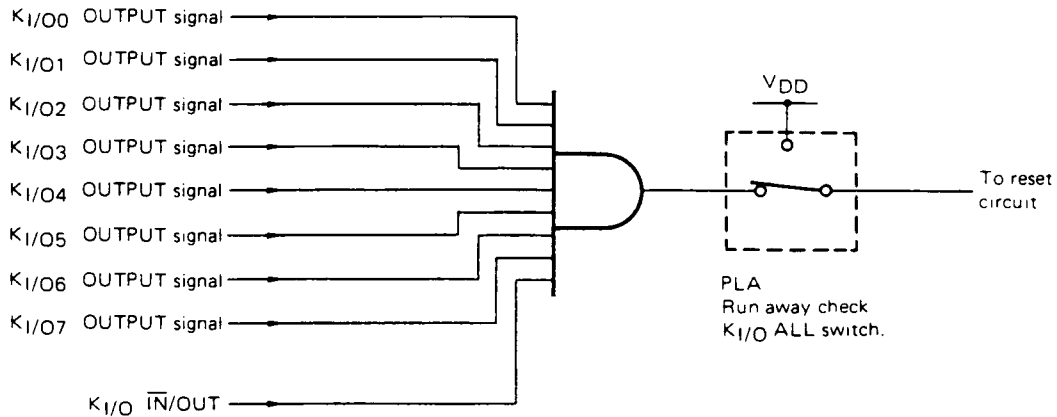
### 1.15 K<sub>I</sub> pull down resistors



There are pull-down resistors.

Whether or not these pull-down resistors can be selected in the MASK OPTION.

### 1.16 Run away check K<sub>1/O</sub> ALL



When the K<sub>1/O</sub> ALL switch is ON, the system reset function will operate by detecting the OSC STOP HALT (stand-by) mode and K<sub>1/O</sub> output levels (not all "H").

This function is useful for a key matrix application. Because in a stand-by mode, all key sources have to be active. If not, some keys will not operate until their key sources will be set to the active level.

### 1.17 CONTROL REGISTER

The control register consists of eight bits. The meanings of these bits are described below.

Table

D <sub>9</sub>	D <sub>8</sub>	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
TEST MODE	*	HALT	D.P. AD <sub>9</sub>	D.P. AD <sub>8</sub>	MOD	TIMER	K <sub>1/O</sub>	RLAcc A <sub>0</sub> ←	
must be set to "0"	NOP	NOP	*	*	f <sub>osc</sub>	STOP	IN	A <sub>3</sub>	0
	NOP	OSC STOP	*	*	f <sub>osc</sub> /12	RUN	OUT	S-IN	1

D<sub>0</sub> : Specifies the data to be input to A<sub>0</sub> when the accumulator is shifted. 0 = A<sub>3</sub> 1 = S-IN

D<sub>1</sub> : Specifies the K<sub>1/O</sub> state. 0 = Input mode 1 = output mode

D<sub>2</sub> : Specifies the timer state. 0 = Clock stop 2 = Clock in

D<sub>3</sub> : Specifies the REM output carrier frequency. 0 = f<sub>osc</sub> 1 = f<sub>osc</sub>/12

D<sub>4</sub>, D<sub>5</sub> : Specifies the two upper bits of the ROM data pointer.

D<sub>6</sub> : Sets the oscillator circuit when a HALT instruction is executed.

0 = Oscillation does not stop

1 = Oscillation stops (stop mode)

D<sub>7</sub> : NOP

D<sub>8</sub>, D<sub>9</sub> : Must be set to 0 (test mode setting register).



## 2. STANDBY FUNCTION (HALT)

The  $\mu$ PD6127 is provided with a standby mode (HALT) to save power while the program is standby. In addition, the control register can stop the oscillator circuit (stop mode).

When the standby mode is selected, program execution stops. The preceding register and data memory contents are saved in this case.

### 2.1 STOP MODE (OSCILLATION STOP: HALT)

In the stop mode, the system clock generation circuit (ceramic oscillation, circuit) stops. Therefore, all the operations that require system clock pulses stop.

If a HALT instruction is executed while the timer is operating, the stop mode is set after completion of countdown by the timer.

### 2.2 HALT MODE (OSCILLATION CONTINUES: HALT)

The CPU stops operation until a halt cancel condition is generated. In this case, the system clock generation circuit continues to operate.

### 2.3 STANDBY CANCEL CONDITION

- (1) S-IN input
- (2)  $K_{I/O}$  input
- (3)  $K_I$  input
- (4) Timer countdown end

\*: When setting a standby cancel condition using an input, either H-level or L-level must be specified.

## 3. AC PIN

Setting the AC pin to the  $V_{SS}$  level will reset the program counter.

Watchdog Timer Function:

A power-on-reset and a CR watchdog timer circuit can be constructed by inserting a  $0.1 \mu\text{F}$  capacitor between the AC pin and  $V_{SS}$ .

#### 4. MASK OPTION (PLA DATA)

Mask option can be used to specify:

- (1)  $K_I$  and S-IN port pull-down resistors selection.
- (2) Carrier duty selection (1/2 or 1/3)
- (3) Run away check mode selection.

#### SW change bit assignments

		M S B						L S B	
		7	6	5	4	3	2	1	0
0	$K_I$	PULL DOWN resistors						0	
1	DUTY, S-IN	0	0	0	DUTY	0	0	S-IN PULL DOWN resistor	0
2	Run away check	$K_{I/O}$ ALL	HALT S-IN	HALT $K_{I/O}$	HALT $K_I$	0			

#### SW for data

- (1) PULL DOWN resistor

{ 0  $\Rightarrow$  Non-existent  
 { 1  $\Rightarrow$  Existent

- (2) Modulation duty (when  $f/12$ )

{ 0  $\Rightarrow$  1/2 Duty  
 { 1  $\Rightarrow$  1/3 Duty

- (3) Run away check

- (a)  $K_{I/O}$  ALL

In OSCILLATION STOP HALT, the system reset function operates when the  $K_{I/O}$  port is a input mode or the  $K_{I/O}$  port output levels are not all H.

{ 0  $\Rightarrow$  Non-reset  
 { 1  $\Rightarrow$  Reset

- (b) HALT S-IN, HALT  $K_{I/O}$ , HALT  $K_I$

In a HALT mode, the system reset function operates when this HALT mode is specified as no use.

{ 0  $\Rightarrow$  use  
 { 1  $\Rightarrow$  no use

Mnemonic ← Machine Word

Accumulator Operation Instructions

R <sub>r</sub>		Machine Word									
		-	R <sub>10</sub>	R <sub>11</sub>	R <sub>12</sub>		R <sub>1F</sub>	R <sub>00</sub>	R <sub>01</sub>		R <sub>C</sub>
ANL A, R <sub>r</sub>			D00	D01	D02		D0F	D20	D21		D2F
ANL A, @R <sub>0H</sub>	D10										
ANL A, @R <sub>0L</sub>	D30										
ANL A, #data	D31										
ORL A, R <sub>r</sub>		E00	E01	E02		E0F	E20	E21		E2F	
ORL A, @R <sub>0H</sub>	E10										
ORL A, @R <sub>0L</sub>	E30										
ORL A, #data	E31										
XRL A, R <sub>r</sub>		A00	A01	A02		A0F	A20	A21		A2F	
XRL A, @R <sub>0H</sub>	A10										
XRL A, @R <sub>0L</sub>	A30										
XRL A, #data	A31										
INC A	A13										
RL A	F13										

Input/Output Instructions

P <sub>p</sub>			P <sub>10</sub>	P <sub>11</sub>	P <sub>12</sub>	P <sub>00</sub>	P <sub>01</sub>	P <sub>02</sub>
IN	A,	P <sub>p</sub>	F18	F19	F1A	F38	F39	F3A
OUT	P <sub>p</sub> ,	A	218	219	21A	238	239	23A
ANL	A,	P <sub>p</sub>	D18	D19	D1A	D38	D39	D3A
ORL	A,	P <sub>p</sub>	E18	E19	E1A	E38	E39	E3A
XRL	A,	P <sub>p</sub>	A18	A19	A1A	A38	A39	A3A

P <sub>p</sub>		P <sub>0</sub>	P <sub>1</sub>	P <sub>2</sub>
OUT	P <sub>p</sub> , #data	318	319	31A

P<sub>1p</sub> - P<sub>0p</sub> operate in pairs.

Data Transfer Instructions

R <sub>r</sub>		R <sub>10</sub>	R <sub>11</sub>	R <sub>12</sub>		R <sub>1F</sub>	R <sub>00</sub>	R <sub>01</sub>		R <sub>0F</sub>
MOV A, R <sub>r</sub>		F00	F01	F02		F0F	F20	F21		F2F
MOV A, @R <sub>0H</sub>	F10									
MOV A, @R <sub>0L</sub>	F30									
MOV A, #data	F31									
MOV R <sub>r</sub> , A		200	201	202		20F	220	221		22F

R <sub>r</sub>		R <sub>0</sub>	R <sub>1</sub>	R <sub>2</sub>		R <sub>F</sub>
MOV R <sub>r</sub> , #data		300	301	302		30F
MOV R <sub>r</sub> , @R <sub>0</sub>		320	321	322		32F

R<sub>1r</sub> - R<sub>0r</sub> operate as pair registers.

### Branch Instructions

		R <sub>r</sub>		R <sub>0</sub>	R <sub>1</sub>	R <sub>2</sub>	R <sub>F</sub>
		-	0				
JMPO	addr	411					
JMPO	R <sub>r</sub>	-	400	401	402		40F
JC	addr	611					
JC	R <sub>r</sub>	-	600	601	602		60F
JNC	addr	631					
JNC	R <sub>r</sub>	-	620	621	622		62F
JF	addr	711					
JF	R <sub>r</sub>	-	700	701	702		70F
JNF	addr	731					
JNF	R <sub>r</sub>	-	720	721	722		72F

← Pair register

### Subroutine Instructions

		Page	
		-	0
CALLO	addr	312	411
RET		412	

### Timer/Counter Operation Instructions

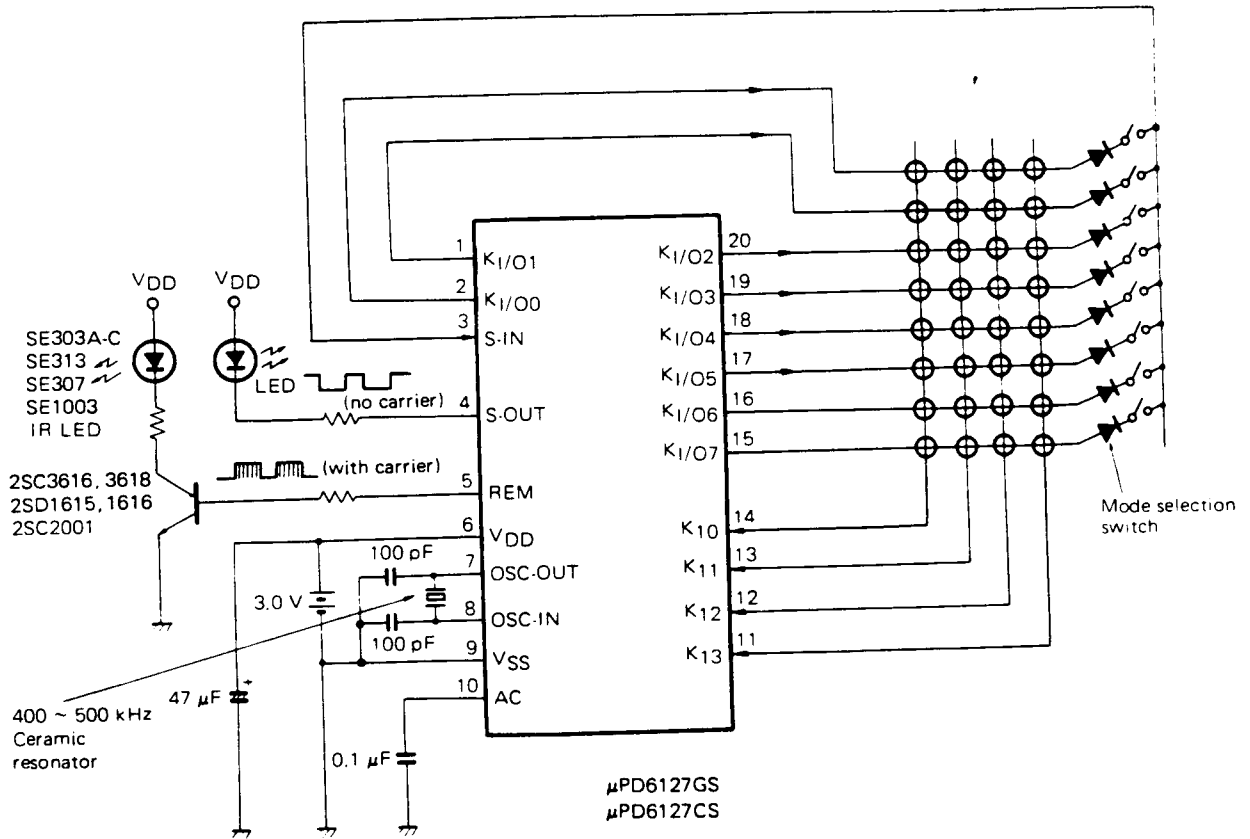
		T <sub>t</sub>		
		T <sub>0-1</sub>	T <sub>1</sub>	T <sub>0</sub>
MOV A, T <sub>t</sub>		-	F1F	F3F
MOV T <sub>t</sub> , A			21F	23F
MOV T, #data		31F		
MOV T, @R <sub>0</sub>		33F		

### Others

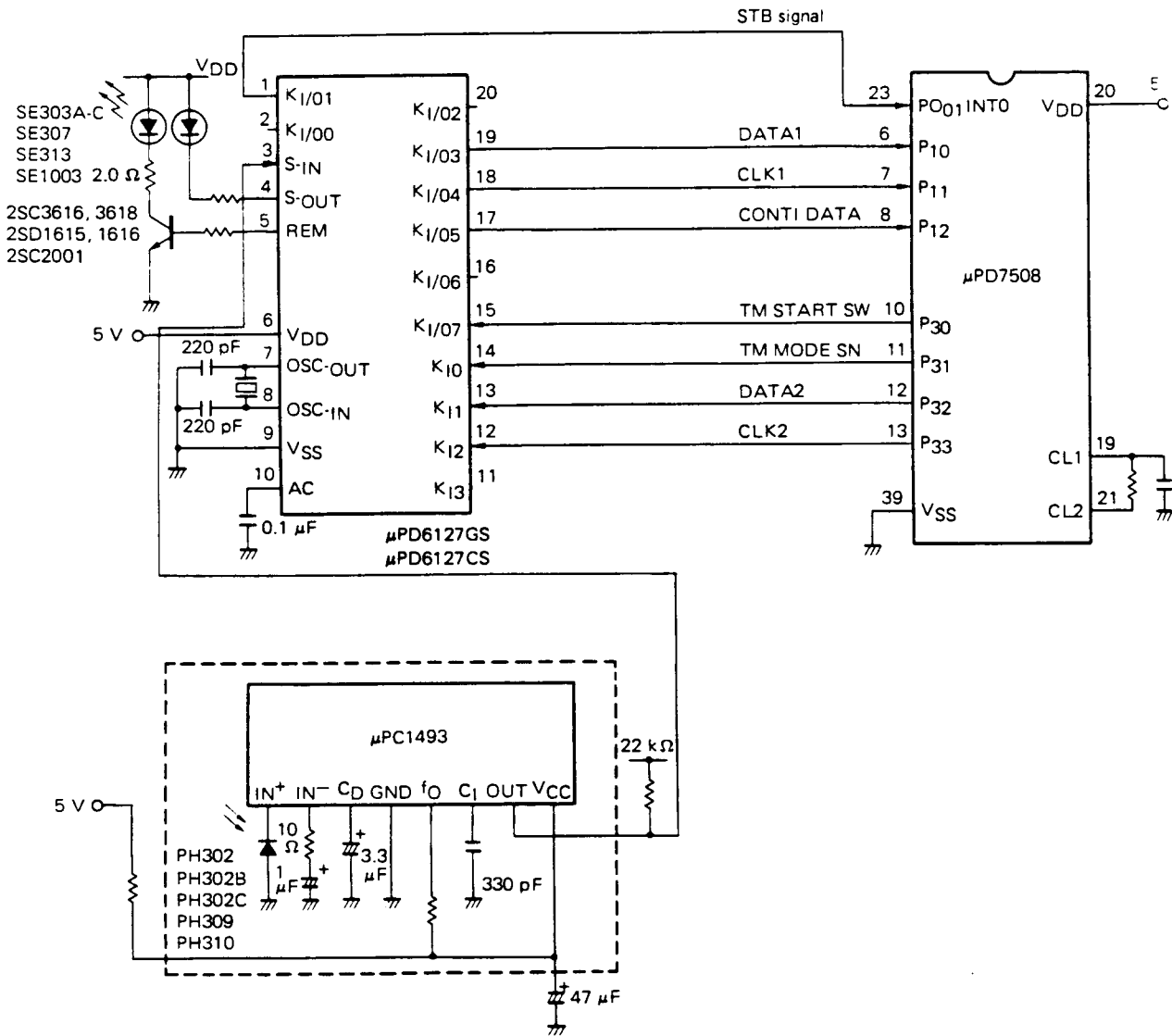
		R <sub>0F</sub>				
		R <sub>00</sub>	R <sub>01</sub>	R <sub>02</sub>		R <sub>0F</sub>
HALT	#data	111				
STTS	R <sub>0r</sub>		120	121	122	
STTS	#data	131				12F
SCAF		D13				
NOP		000				

# APPLICATION

## INFRARED REMOTE CONTROL TRANSMITTER



# APPLICATION



$\mu$ PD6127 can use as a transmitter and a receiver.  
 At this time,  $\mu$ PD7500 series is used as a system computer.

**ABSOLUTE MAXIMUM RATINGS ( $T_a = 25^\circ\text{C}$ )**

Supply voltage	$V_{DD}$	7.0	V
Input voltage	$V_{IN}$	-0.3 to $V_{DD} + 0.3$	V
Operating temperature	$T_{opt}$	-20 to + 75	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-40 to +125	$^\circ\text{C}$

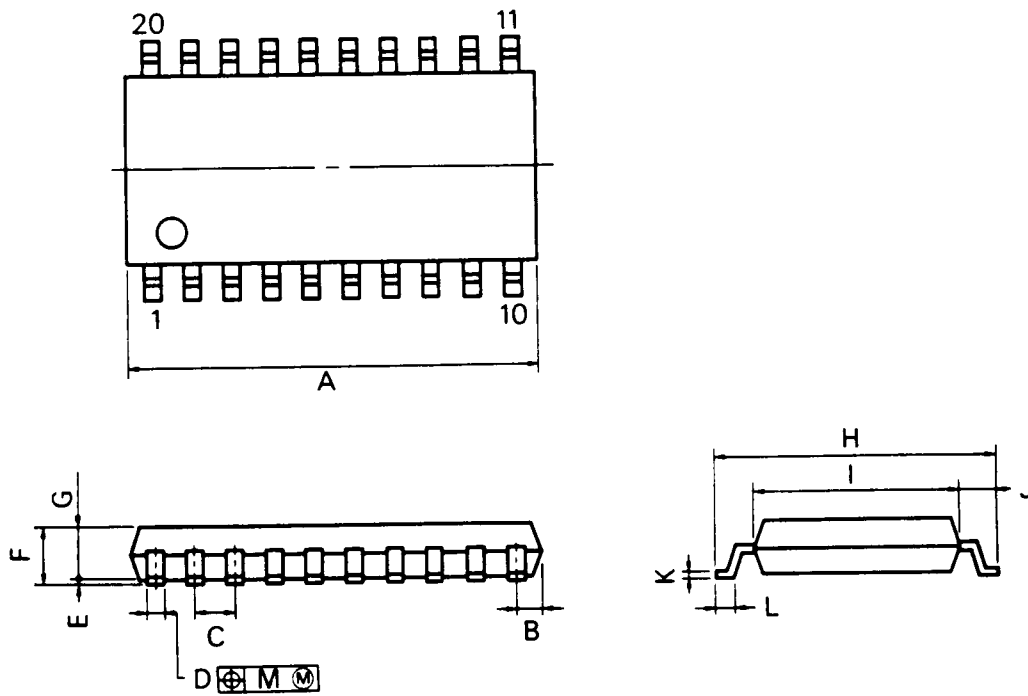
**RECOMMENDED OPERATING CONDITIONS ( $T_a = 25^\circ\text{C}$ )**

CHARACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage	$V_{DD}$	2.0		6.0	V
Oscillation frequency	$f_{OSC}$	400		500	kHz

**ELECTRICAL CHARACTERISTICS ( $V_{DD} = 3.0\text{ V}$ ,  $f_{OSC} = 455\text{ kHz}$ ,  $T_a = 25^\circ\text{C}$ )**

CHARACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITION
Supply voltage	$V_{DD}$	2.0		6.0	V	
Current consumption 1	$I_{DD1}$		0.3	1.0	mA	$f_{OSC} = 455\text{ kHz}$
Current consumption 2	$I_{DD2}$			1.0	$\mu\text{A}$	$f_{OSC} = \text{STOP}$
REM high-level output current	$I_{OH1}$	-5	-8		mA	$V_O = 1.0\text{ V}$
REM low-level output current	$I_{OL1}$	0.5	1.5	2.5	mA	$V_O = 0.3\text{ V}$
S-OUT high-level output current	$I_{OH2}$	-0.3	-1.0	-2.0	mA	$V_O = 2.7\text{ V}$
S-OUT low-level output current	$I_{OL2}$	1	1.5		mA	$V_O = 0.3\text{ V}$
$K_I$ high-level input current	$I_{IH1}$	10		30	$\mu\text{A}$	$V_I = V_{DD}$
$K_I$ high-level input current	$I_{IH1}'$			0.2	$\mu\text{A}$	$V_I = V_{DD}$ (without pull-down resistor)
$K_I$ low-level input current	$I_{IL1}$			-0.2	$\mu\text{A}$	$V_I = V_{SS}$
$K_{I/O}$ high-level input current	$I_{IH2}$	10		30	$\mu\text{A}$	$V_I = V_{DD}$
$K_{I/O}$ high-level input current	$I_{IH2}'$			0.2	$\mu\text{A}$	$V_I = V_{DD}$ (without pull-down resistor)
$K_{I/O}$ low-level input current	$I_{IL2}$			-0.2	$\mu\text{A}$	$V_I = V_{SS}$
$K_{I/O}$ high-level output current	$I_{OH3}$	-1.5	-2.0	-4.0	mA	$V_O = 2.5\text{ V}$
$K_{I/O}$ low-level output current	$I_{OL3}$	25	50	100	$\mu\text{A}$	$V_O = 2.1\text{ V}$
S-IN high-level input current	$I_{IH3}$	6		15	$\mu\text{A}$	$V_I = V_{DD}$
S-IN high-level input current	$I_{IH3}'$			0.2	$\mu\text{A}$	$V_I = V_{DD}$ (without pull-down resistor)
S-IN low-level input current	$I_{IL3}$			-0.2	$\mu\text{A}$	$V_I = V_{SS}$
$K_I$ high-level input voltage	$V_{IH1}$	$0.7 V_{DD}$		$V_{DD}$	V	
$K_I$ low-level input voltage	$V_{IL1}$	$V_{SS}$		$0.3 V_{DD}$	V	$V_I = V_{DD}$
$K_{I/O}$ high-level input voltage	$V_{IH2}$	1.3			V	
$K_{I/O}$ low-level input voltage	$V_{IL2}$			0.4	V	
S-IN high-level input voltage	$V_{IH3}$	1.1			V	
AC pin pull up resistance	$R_1$	0.3		3.0	$\text{k}\Omega$	$V_I = V_{SS}$
AC high level input voltage	$R_2$	150	400	1500	$\text{k}\Omega$	$V_I = 2.7\text{ V}$
AC high level input voltage	$V_{IH4}$	$0.6 V_{DD}$		$V_{DD}$	V	
AC low level input voltage	$V_{IL4}$	$V_{SS}$		$0.4 V_{DD}$	V	

20-PIN PLASTIC SOP (300 mil)



P20GM-50-300B.C-1

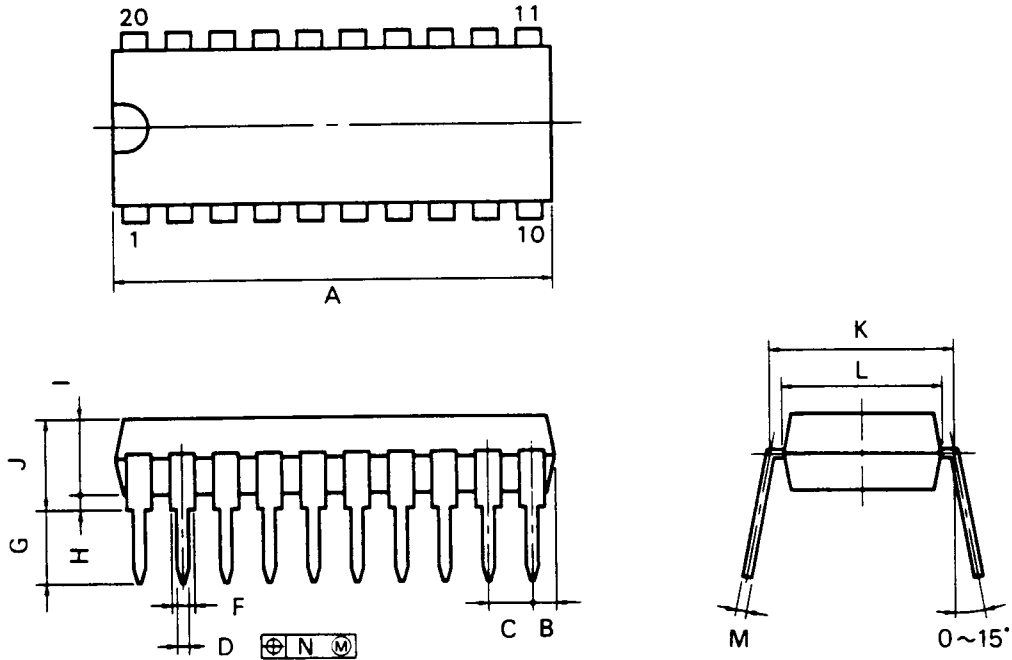
**NOTE**

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS	INCHES
A	13.00 MAX.	0.512 MAX.
B	0.78 MAX.	0.031 MAX.
C	1.27 (T.P.)	0.050 (T.P.)
D	0.40 $\begin{smallmatrix} +0.10 \\ -0.05 \end{smallmatrix}$	0.016 $\begin{smallmatrix} +0.004 \\ -0.003 \end{smallmatrix}$
E	0.1 $\pm 0.1$	0.004 $\pm 0.004$
F	1.8 MAX.	0.071 MAX.
G	1.55	0.061
H	7.7 $\pm 0.3$	0.303 $\pm 0.012$
I	5.6	0.220
J	1.1	0.043
K	0.20 $\begin{smallmatrix} +0.10 \\ -0.05 \end{smallmatrix}$	0.008 $\begin{smallmatrix} +0.004 \\ -0.003 \end{smallmatrix}$
L	0.6 $\pm 0.2$	0.024 $\begin{smallmatrix} +0.008 \\ -0.006 \end{smallmatrix}$
M	0.12	0.005



20-PIN PLASTIC SHRINK DIP (300 mil)



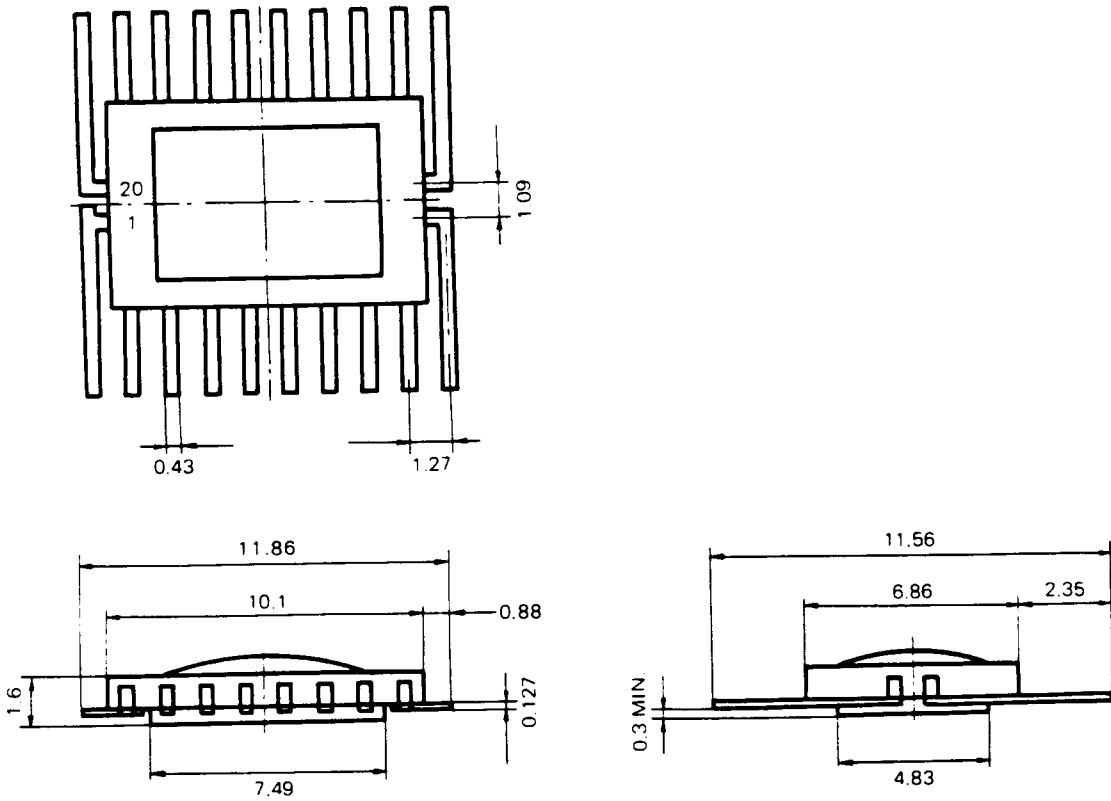
P20C-70-300B

NOTES

- 1) Each lead centerline is located within 0.17 mm (0.007 inch) of its true position (T.P.) at maximum material condition.
- 2) Item "K" to center of leads when formed parallel.

ITEM	MILLIMETERS	INCHES
A	19.57 MAX.	0.771 MAX.
B	1.78 MAX.	0.070 MAX.
C	1.778 (T.P.)	0.070 (T.P.)
D	0.50 <sup>0</sup> / <sub>0.10</sub>	0.020 <sup>0</sup> / <sub>0.004</sub>
F	0.85 MIN.	0.033 MIN.
G	3.2 <sup>0</sup> / <sub>0.3</sub>	0.126 <sup>0</sup> / <sub>0.012</sub>
H	0.51 MIN.	0.020 MIN.
I	4.31 MAX.	0.170 MAX.
J	5.08 MAX.	0.200 MAX.
K	7.62 (T.P.)	0.300 (T.P.)
L	6.5	0.256
M	0.25 <sup>0</sup> / <sub>0.08</sub>	0.010 <sup>0</sup> / <sub>0.003</sub>
N	0.17	0.007

ES 20-PIN CERAMIC SOP (Unit: mm)



ES 20-PIN SHRINK DIP (Unit: mm)

